

RESIN-COATED COMPOSITE FOIL, PRODUCTION AND USE THEREOF**ABSTRACT**

The resin-coated composite foil of the invention is characterized in that an organic insulation layer is disposed in an ultra-thin copper foil which is disposed on a supporting metal layer through an intermediate organic release layer. The process for producing resin coated copper foil of the invention is characterized by comprising the steps of forming an organic release layer on a supporting metal layer, forming an ultra-thin copper foil on the organic release layer and forming an organic insulating layer on the ultra-thin copper foil. According to the present invention, there can be provided a resin-coated composite foil which is free from the peeling or blistering between the supporting metal foil and the ultra-thin copper foil during the production of a copper-clad laminate, a process for producing the same, a process for producing a multi-layer copper clad laminate using the copper-clad laminate which has excellent laser and plasma workability and a printed wiring board having fine wirings and via holes.

Figure 1